



US00D685334S

(12) **United States Design Patent**  
**Chu et al.**

(10) **Patent No.:** **US D685,334 S**  
(45) **Date of Patent:** **\*\* Jul. 2, 2013**

(54) **LED CHIP**

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(\*\*) Term: **14 Years**

(21) Appl. No.: **29/419,098**

(22) Filed: **Apr. 25, 2012**  
(Under 37 CFR 1.47)

(30) **Foreign Application Priority Data**

Oct. 28, 2011 (TW) ..... 100305816

(51) **LOC (9) Cl.** ..... **13-03**

(52) **U.S. Cl.**  
USPC ..... **D13/180**

(58) **Field of Classification Search**  
USPC ..... D13/180; D26/1; 257/79, 80, 81,  
257/88, 89, 95, 98, 99, 100, E33.058; 313/483,  
313/498, 500; 362/555, 800  
See application file for complete search history.

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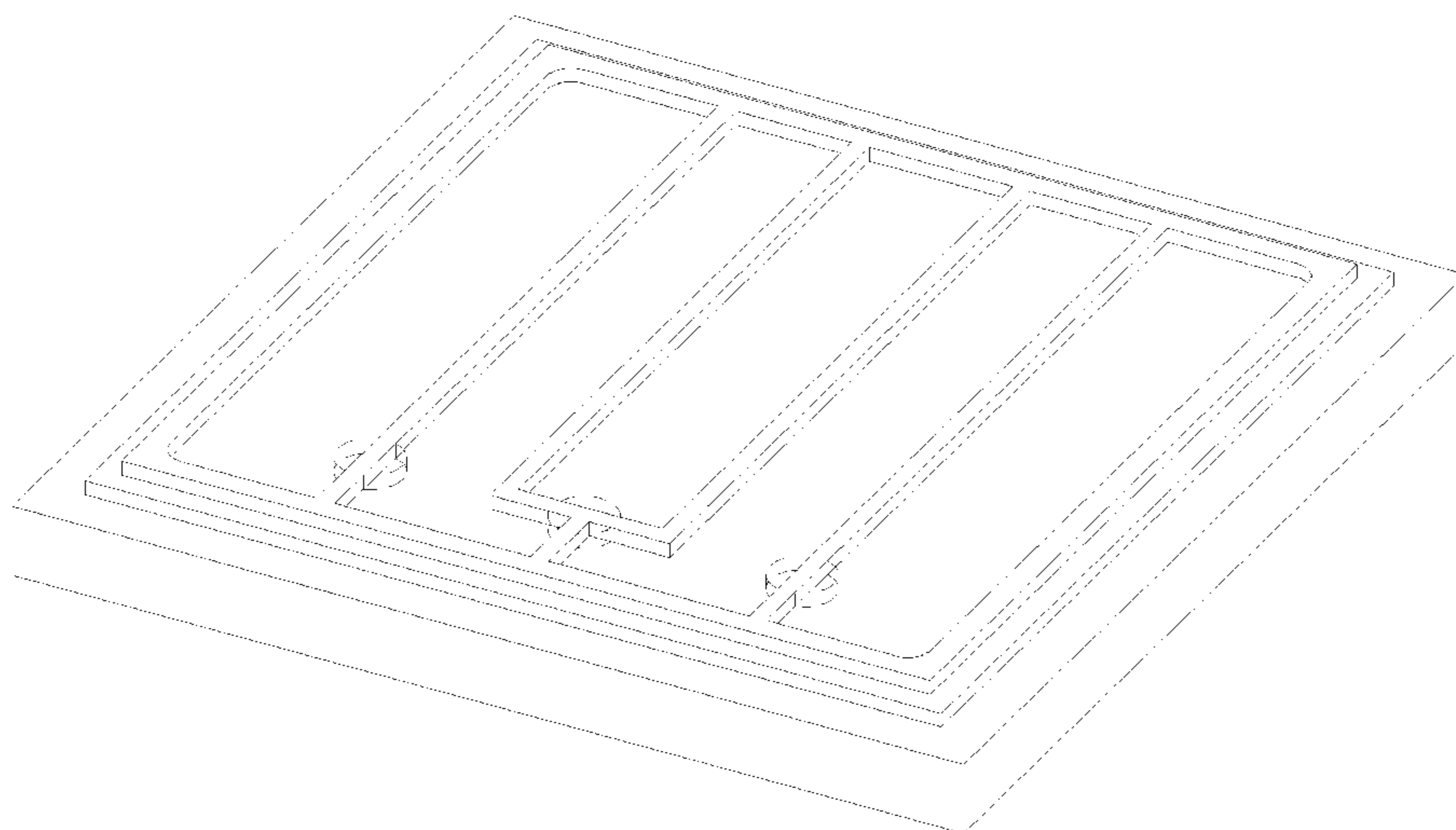
(57) **CLAIM**

The ornamental design for a LED chip, as shown and described in the drawings.

**DESCRIPTION**

FIG. 1 is a perspective view of a light emitting diode device showing my new design;  
 FIG. 2 is a top view thereof;  
 FIG. 3 is a front view thereof;  
 FIG. 4 is a back view thereof;  
 FIG. 5 is a left view thereof;  
 FIG. 6 is a right view thereof;  
 FIG. 7 is a cross-sectional view thereof, take along line 7-7 in FIG. 2;  
 FIG. 8 is a cross-sectional view thereof, take along line 8-8 in FIG. 2;  
 FIG. 9 is a right side view of thereof; the left side view is a mirror image of the right side view; and,  
 FIG. 10 is a front view of thereof; the backside view is a mirror image of the front side view.  
 It will be understood that the dash lines presented in the drawings are for illustration only, and do not form a part of the claimed design.

**1 Claim, 8 Drawing Sheets**



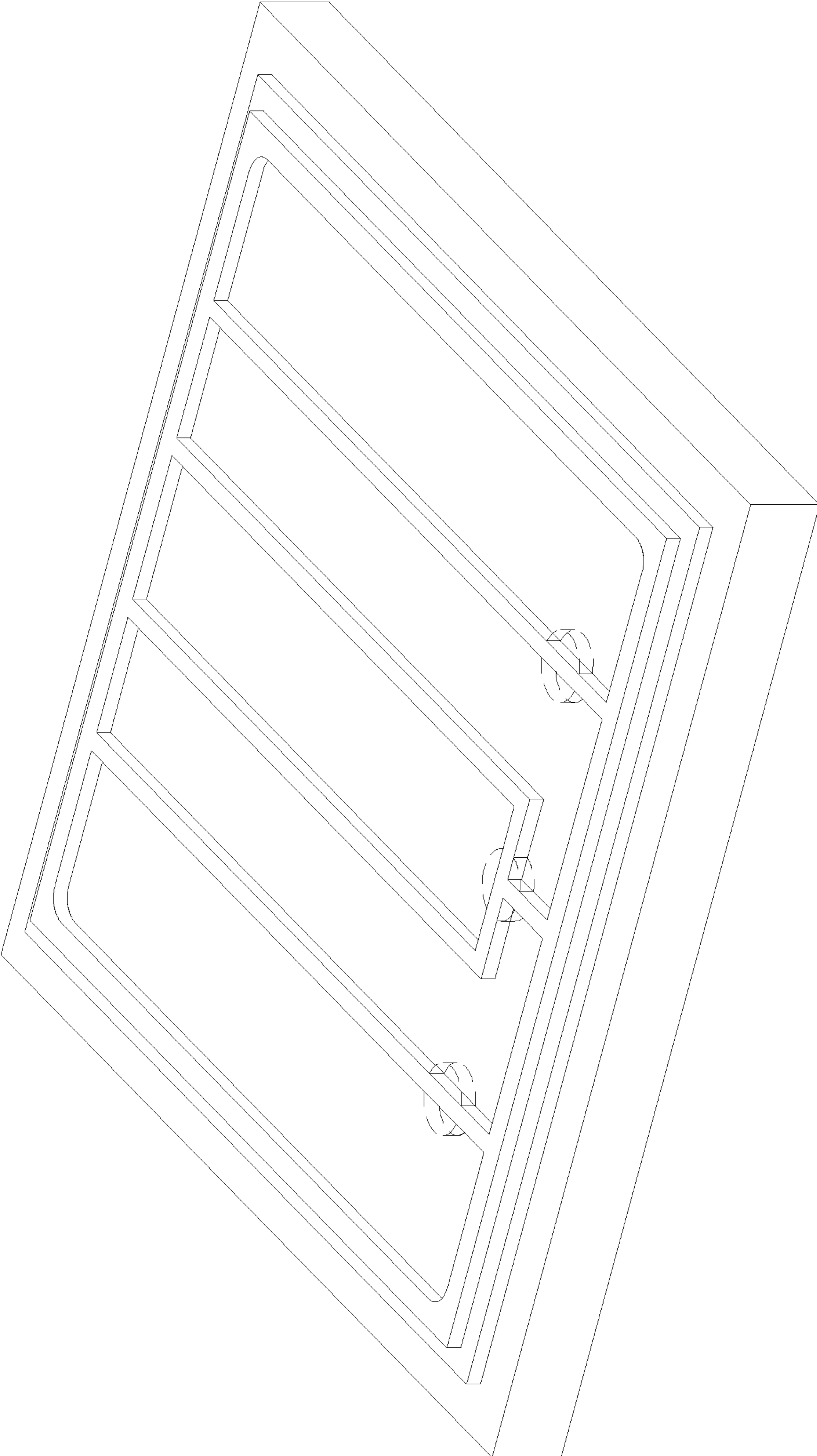


Fig. 1

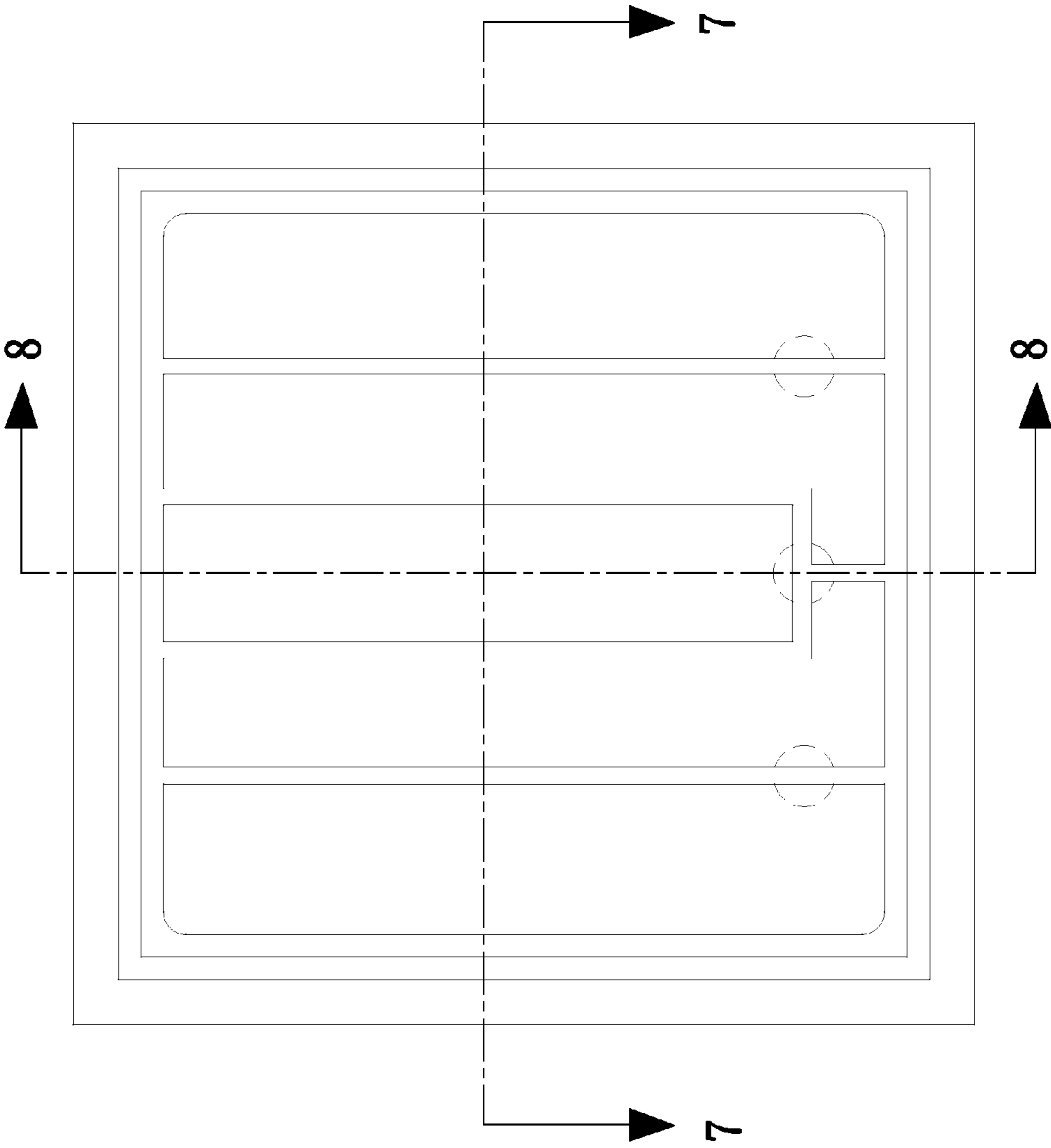


Fig. 2

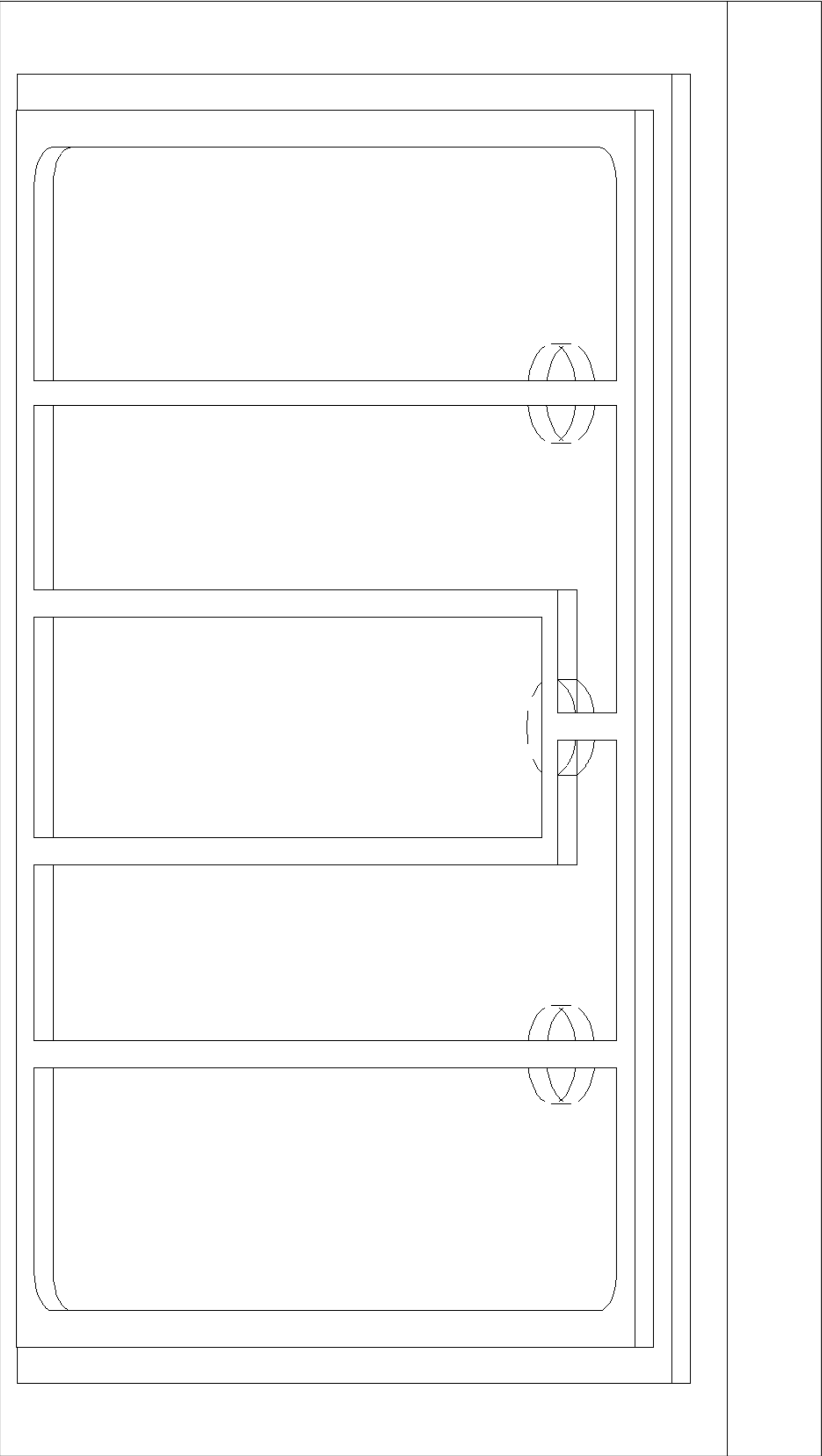


Fig. 3

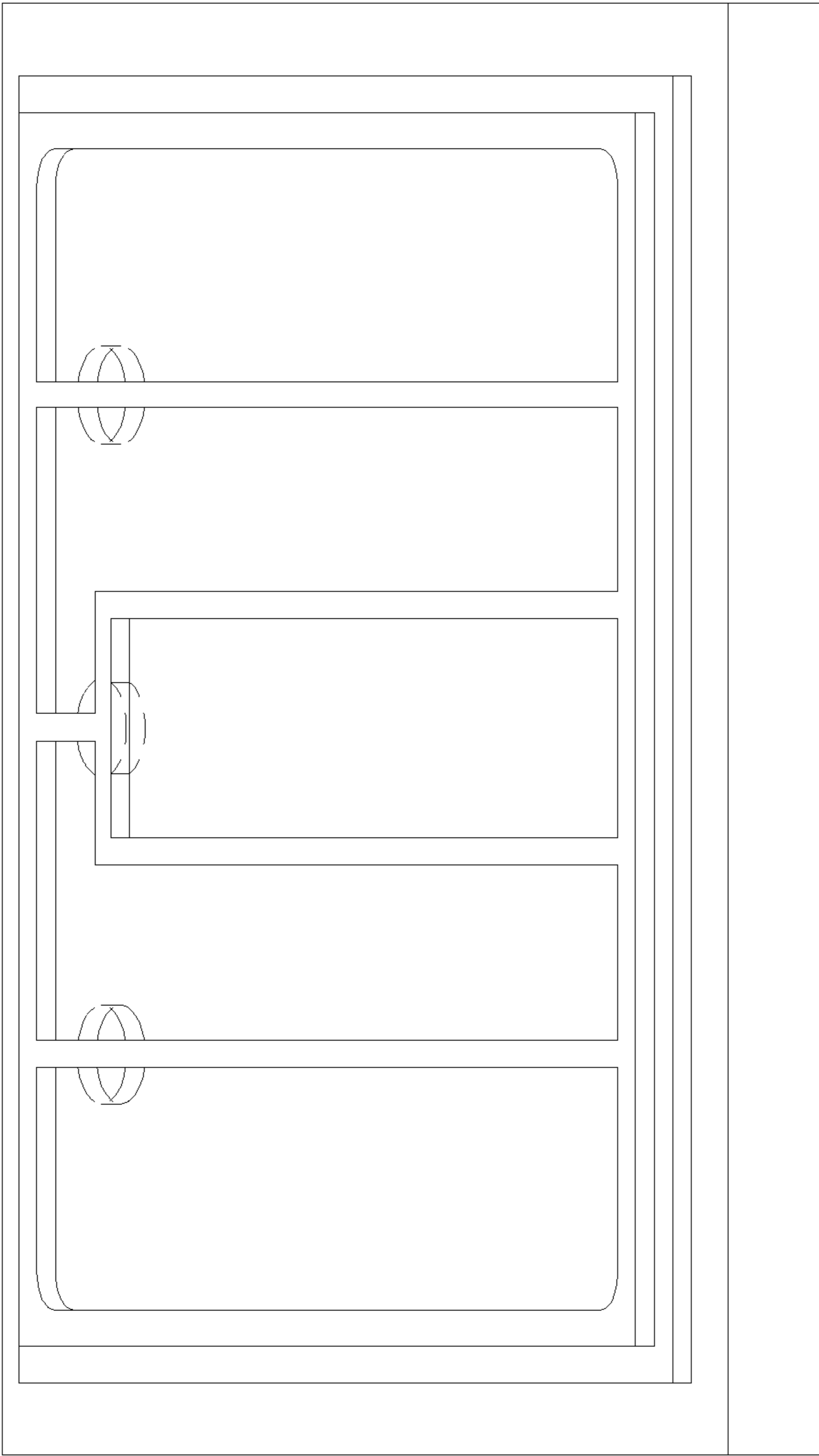


Fig. 4

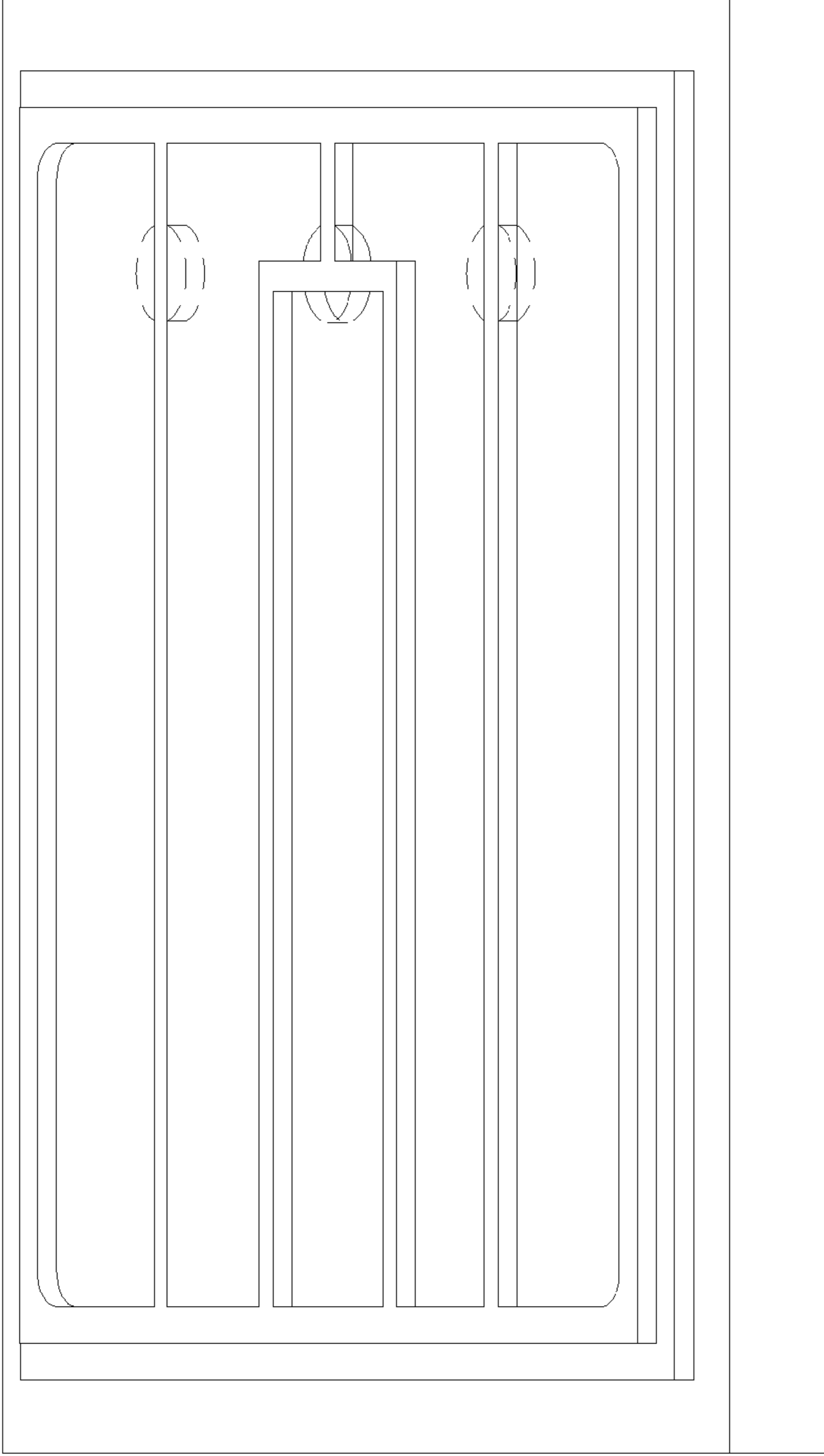


Fig. 5

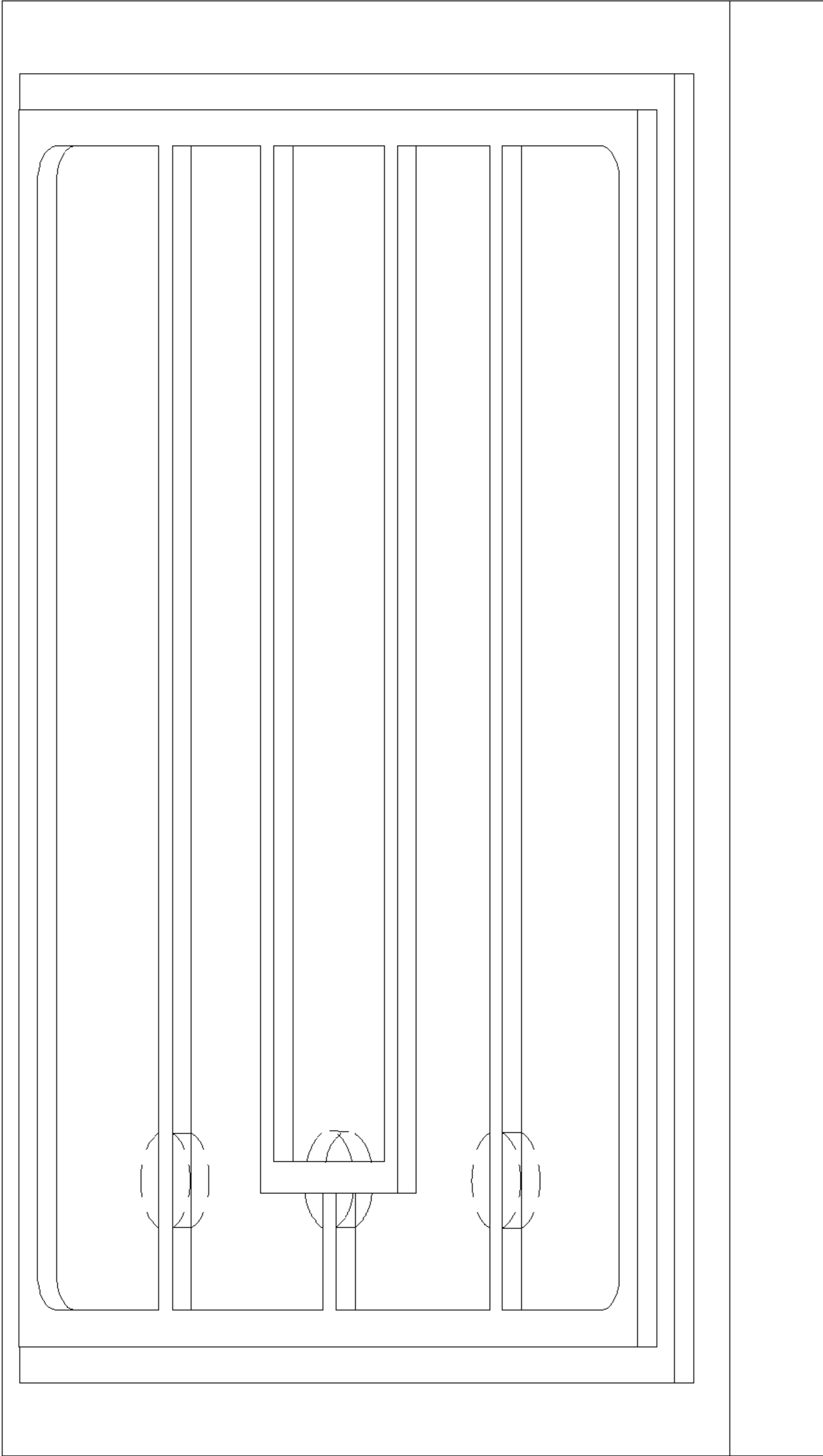


Fig. 6

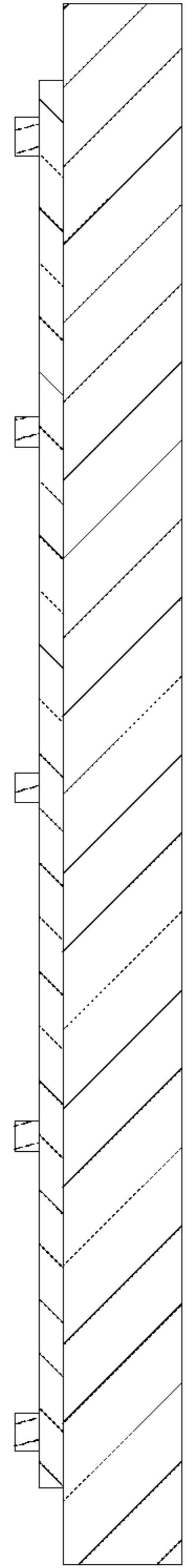


Fig. 7

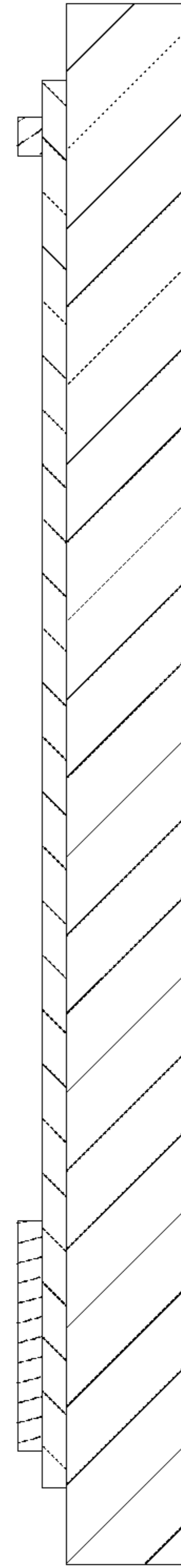


Fig. 8



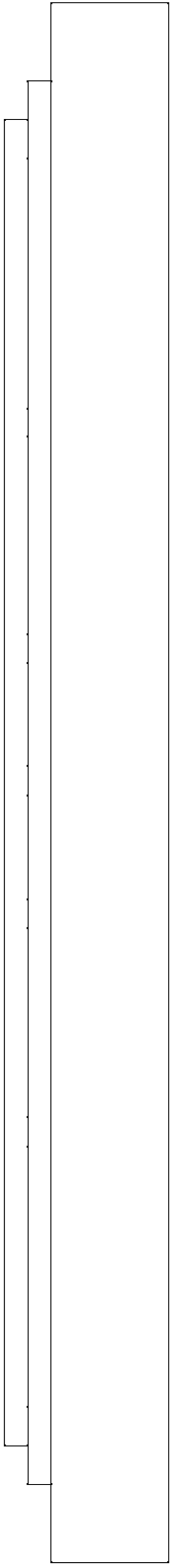


Fig. 9

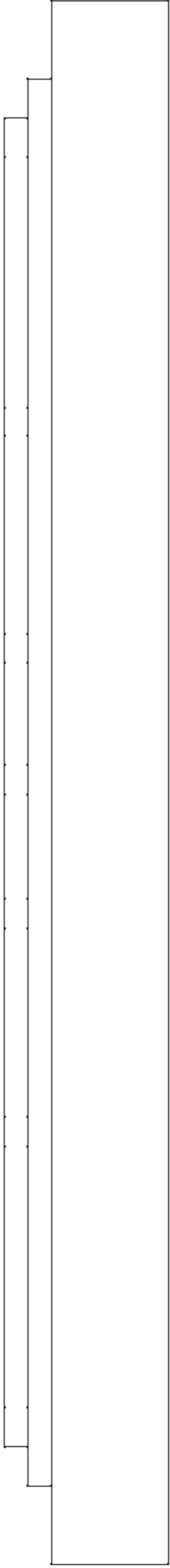


Fig. 10